### **Dual Output LCD Bias for Smartphones and Tablets**

### **General Description**

The RT4801T is a highly integrated Boost and LDO and inverting charge pump to generate positive and negative output voltage. The output voltages can be adjusted from  $\pm 4V$  to  $\pm 6V$  with 100mV steps by I<sup>2</sup>C interface protocols. With its input voltage range of 2.5V to 5.5V, the RT4801T is optimized for products powered by single-cell batteries and symmetrical output currents up to 150mA. The RT4801T is available in the WL-CSP-15B 1.31x2.07 (BSC) package.

### **Ordering Information**

RT4801T 🗖

-Package Type WSC : WL-CSP-15B 1.31x2.07 (BSC)

Note :

Richtek products are :

- ► RoHS compliant and compatible with the current requirements of IPC/JEDEC J-STD-020.
- ► Suitable for use in SnPb or Pb-free soldering processes.

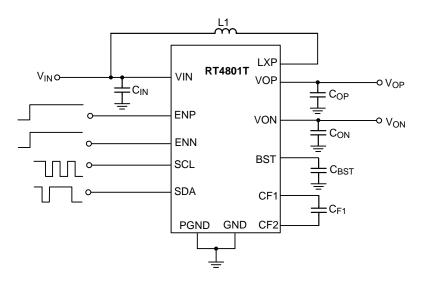
### Features

- 2.5V to 5.5V Supply Voltage Range
- Up to 90% Efficiency with Small Magnetics
- Support Up to 150mA Output Current
- Low 1µA Shut Down Current
- Internal Soft-start Function
- Short Circuit Protection Function
- Over-Voltage Protection Function
- Over-Current Protection Function
- Over-Temperature Protection Function
- Elastic Positive and Negative Voltage On/Off Control by ENP/ENN
- Voltage Output from 4V to 6V per 0.1V
- Low Input Noise and EMI
- Output with Programmable Fast Discharge when IC Shut Down
- Adjustable Output Voltage by I<sup>2</sup>C Compatible Interface
- Available in the 15-Ball WL-CSP Package

### Applications

- TFT-LCD Smartphones
- TFT-LCD Tablets
- General Dual Power Supply Applications

### **Simplified Application Circuit**





**Marking Information** 

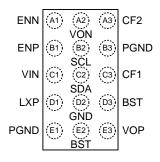
7UW

7U : Product Code

W : Date Code

### **Pin Configuration**





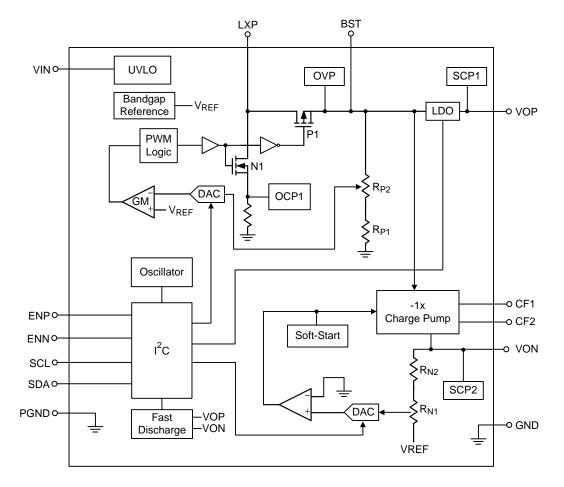
WL-CSP-15B 1.31x2.07 (BSC)

### **Functional Pin Description**

Pin No.	Pin Name	Pin Function
A1	ENN	Enable control input for VON.
A2	VON	Negative terminal output.
A3	CF2	Negative charge pump flying capacitor pin.
B1	ENP	Enable control input for VOP.
B2	SCL	Clock of I <sup>2</sup> C.
B3, E1	PGND	Power ground.
C1	VIN	Power input.
C2	SDA	Data of I <sup>2</sup> C.
C3	CF1	Negative charge pump flying capacitor pin.
D1	LXP	Switching node of boost converter.
D2	GND	Ground. The exposed pad must be soldered to a large PCB and connected to GND for maximum power dissipation.
D3, E2	BST	Output voltage of boost converter.
E3	VOP	Positive terminal output.

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### **Functional Block Diagram**



### Operation

The RT4801T is a highly integrated Boost, LDO and inverting charge pump to generate positive and negative output voltages for LCD panel bias or consumer products. It can support input voltage range from 2.5V to 5.5V and the output current up to 150mA. Both positive and negative voltages can be programmed by a MCU through the dedicated  $I^2C$  interface. The RT4801T provides Over-Temperature Protection (OTP) and Short Circuit Protection (SCP) mechanisms to prevent the device from damage with abnormal operations. When the EN voltage is logic low for more than  $375\mu$ s, the IC will be shut down with low input supply current less than  $1\mu$ A.

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### Absolute Maximum Ratings (Note 1)

• VIN, BST, VOP, ENP, ENN, CF1, LXP, SCL and SDA	- –0.3V to 7V
• LXP (< 100ns)	2.4V to 10.7V
VON and CF2	7V to 0.3V
<ul> <li>Power Dissipation, PD @ TA = 25°C</li> </ul>	
WL-CSP-15B 1.31x2.07 (BSC)	- 2.00W
Package Thermal Resistance (Note 2)	
WL-CSP-15B 1.31x2.07 (BSC), θJA	- 49.8°C/W
Lead Temperature (Soldering, 10 sec.)	- 260°C
Junction Temperature	- 150°C
Storage Temperature Range	- −65°C to 150°C
ESD Susceptibility (Note 3)	
HBM (Human Body Model)	- 2kV

### **Recommended Operating Conditions (Note 4)**

•	Supply Input Voltage	- 2.5V to 5.5V
•	Ambient Temperature Range	- –40°C to 85°C
•	Junction Temperature Range	- –40°C to 125°C

### **Electrical Characteristics**

 $(V_{IN} = 3.7V, C_{IN} = C_{OP} = C_{F1} = 4.7\mu F, C_{BST} = C_{ON1} = C_{ON2} = 10\mu F, L1 = 2.2\mu H, T_A = 25^{\circ}C, unless otherwise specified.)$ 

Parameter	Symbol	Test Conditions	Min	Тур	Мах	Unit
Power Supply		·				
Input Voltage Range	Vin		2.5		5.5	V
Under Voltage Lockout	Vuvlo_h	VIN Rising		-	2.5	V
Threshold Voltage	Vuvlo_l	Vin Falling			2.3	v
Over-Temperature Protection	Тотр	(Note 5)		140		°C
Over-Temperature Protection Hysteresis	TOTP_HYST	(Note 5)		15		°C
Shut Down Current	ISHDN	ENP = ENN = 0V			1	μΑ
Boost Converter						
Boost Voltage Range	VBST		4.15		6.2	V
Peak Current Limit	IOCP			1.3		А
Boost Switching Frequency	fosc_p		0.8	1	1.2	MHz
LDO						
Positive Output Voltage Range	Vop		4		6	V
Positive Output Voltage Setting Range	VOP_SET	Per step		100		mV
Positive Output Voltage Accuracy	VOP_ACC		-1		1	%

### **RT4801T**

Parame	ter	Symbol	Test Conditions	Min	Тур	Max	Unit
Positive Output Cu Capability	ırrent	IOP_MAX				150	mA
Dropout Voltage		VOP_DROP	V <sub>BST</sub> = 5.4V, V <sub>OP</sub> = 5.4V, I <sub>OP</sub> = 100mA			150	mV
Line Regulation		$\Delta VLINE_OP$	VIN = 2.5 to 5.5V, IOP = 40mA		2		mV
Load Regulation		$\Delta V_{LOAD\_OP}$	∆l <sub>OP</sub> = 80mA		3		%/A
Short Circuit Prote	ction Current	IOP_SC			250		mA
Fast Discharge Re	sistance	RDISP			70		Ω
Negative Charge	Pump						
Negative Output V Range	oltage	Von		-4		-6	V
Negative Output V Setting Range	oltage	Von_set	Per step		100		mV
Negative Output V Accuracy	oltage	Von_acc		-1		1	%
Negative Output C Capability	urrent	ION_MAX				150	mA
Negative Charge F Switching Frequer	•	fosc_n		0.8	1	1.2	MHz
Line Regulation		$\Delta VLINE_ON$	VIN = 2.5 to 5.5V, ION = 40mA		mV		
Load Regulation		$\Delta VLOAD_ON$	ΔION = 80mA		6		%/A
Short Circuit Prote	ction Level	Von_sc	Percentage of target value		75		%
Fast Discharge Re	sistance	RDISN			20		Ω
Logic Input (ENP,	ENN, SCL, S	SDA)				-	
Input Threshold	Logic-High	Viн	VIN =2.5V to 5.5V	1.2			v
Voltage	Logic-Low	VIL	V <sub>IN</sub> =2.5V to 5.5V			0.4	v
ENP, ENN Pull-do Resistance	wn	Ren			200		kΩ
SDA, SCL Sink Cu	irrent	Іін	VSDA, VSCL = 3V		0.5		μΑ
SDA, SCL Logic	Low-Level	Vscl_l				0.4	v
Input Voltage	High-Level	Vscl_h		1.2			v
SCL Clock Freque	ncy	fCLK				400	kHz
Output Fall Time		tFL2COUT				250	ns
Bus Free Time Be Stop/Start	tween	tBUF		1.3			μS
Hold Time Start Co	ondition	thd,sta		0.6			μS
Setup Time for Sta	rt Condition	tsu,sta		0.6			μS
SCL Low Time		tLOW		1.3			μS
SCL High Time		tнigн		0.6			μS
Data Setup Time		tsu,dat		100			ns
Data Hold Time		thd,dat		0		900	ns

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Parameter	Symbol	Test Conditions	Min	Тур	Мах	Unit
Setup Time for Stop Condition	tsu,sto		0.6	-		μS

**Note 1.** Stresses beyond those under listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions may affect device reliability.

Note 2.  $\theta_{JA}$  is measured under natural convection (still air) at  $T_A = 25^{\circ}C$  with the component mounted on a high effective-thermal-conductivity four-layer test board on a JEDEC 51-7 thermal measurement standard.

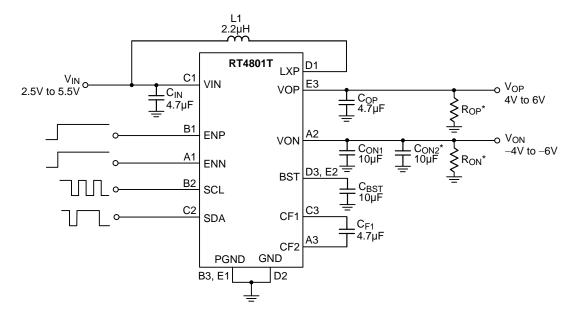
Note 3. Devices are ESD sensitive. Handling precaution recommended.

Note 4. The device is not guaranteed to function outside its operating conditions.

Note 5. TOTP, TOTP\_HYST are guaranteed by design.

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### **Typical Application Circuit**

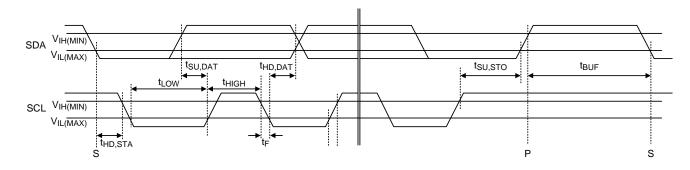


- $^{*}$  : (1)  $R_{OP}$  and  $R_{ON}$  should be paralleled with  $V_{OP}$  and  $V_{ON}$  if output continuous discharge is required when channel is powered off.
  - (2)  $C_{ON2}$  is suggest to be paralleled with  $C_{ON1}$  to get better performance when output 150mA application.

Reference	Qty	Part Number	Description	Package	Supplier
CIN, COP, CF1	1	GRM188R61C475KAAJ	4.7μF/16V/X5R	0603	Murata
CBST, CON1, CON2	1	GRM188R61C106KAAL	10μF/16V/X5R	0603	Murata
L1	1	1269AS-H-2R2N=P2	$2.2 \mu H/130 m \Omega$	2.5 x 2.0 x 1.0mm	Toko



### I<sup>2</sup>C Interface



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### I<sup>2</sup>C Command

#### Slave Address

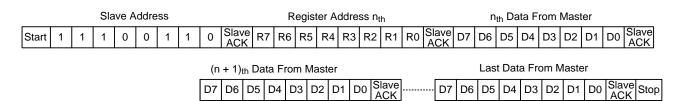
Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0 = LSB
1	1	1	0	0	1	1	R/W

#### Write Command

(a) Write single byte of data to Register

Slave Address											Register Address								Data From Master								
	Start	1	1	1	0	0	1	1	0	Slave ACK R7	R6	R5	R4	R3	R2	R1	R0	Slave D	' D6	D5	D4	D3	D2	D1	D0	Slave Stop	

#### (b) Write multiple bytes of data to Registers



#### **Read Command**

(a) Read single byte of data from Register

			Sla	ave A	٩ddre	ess			Register Address										
Start	1	1	1	0	0	1	1	0	Slave ACK	D7 [	D6	D5	D4	D3	D2	D1	D0	Slave ACK	
			Sla	ave A	٩ddre	ess					Da	ata F	rom	Mas	ter				
Re- start	1	1	1	0	0	1	1	1	Slave ACK	D7 [	D6	D5	D4	D3	D2	D1	D0	Master NACK	Sto

#### (b) Read multiple bytes of data from Registers

	Slave Address Register Address																															
Start 1	1	1	0	0	1	1	0	Slav ACk	e D7	D6	D5	D4	D3	D2	D	01 D0	Sla A	ave CK														
Re- start 1	1	Sla 1	ave A	.ddre 0	ess	1	1	Slav	e D7					aster D2		01 D0	Ma	aster CK		[[	07 D		ast D						Mas	ter	Stop	]
Start : St	tart o	com	nma	nd				<u>.</u>		•	•					ACK	: A	\ckr	nowle							•			•			
R7 to R0	) : R	egis	ster	Ad	dre	ss.										D7 t	οC	00:	Writ	te	data	a w	hen	WI	RIT	Εc	com	nma	and	or	rea	d
VOP : Re	egis	ter	addı	res	s =	0X(	)0h	I								data	wh	nen	REA	D	com	nma	and									
VON : Re	egis	ter	add	res	s =	0X(	01h	1								Stop	) : S	Stop	con	nm	and											
DISP : R	egis	ster	add	lres	ss =	: 0x(	03h	1																								
DISN : R	legis	ster	add	lres	ss =	= 0x	03ŀ	1																								
APPS : F	Regi	stei	r ade	dre	SS =	= 0>	(03	h																								
R/W : Re	R/W : Read active ( $R/W = H$ ) or Write active ( $R/W = L$ )																															

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#### **Registers Map**

#### **Table 2. VOP Voltage Selection**

Name	Register Address	DATA	Bit7	Bit6	Bit5	Bit4	Bit3	Bit2	Bit1	Bit0	VOP(V)
VOP	00h	00h	Reserved	Reserved	Reserved	0	0	0	0	0	4
VOP	00h	01h	Reserved	Reserved	Reserved	0	0	0	0	1	4.1
VOP	00h	02h	Reserved	Reserved	Reserved	0	0	0	1	0	4.2
VOP	00h	03h	Reserved	Reserved	Reserved	0	0	0	1	1	4.3
VOP	00h	04h	Reserved	Reserved	Reserved	0	0	1	0	0	4.4
VOP	00h	05h	Reserved	Reserved	Reserved	0	0	1	0	1	4.5
VOP	00h	06h	Reserved	Reserved	Reserved	0	0	1	1	0	4.6
VOP	00h	07h	Reserved	Reserved	Reserved	0	0	1	1	1	4.7
VOP	00h	08h	Reserved	Reserved	Reserved	0	1	0	0	0	4.8
VOP	00h	09h	Reserved	Reserved	Reserved	0	1	0	0	1	4.9
VOP	00h	0Ah	Reserved	Reserved	Reserved	0	1	0	1	0	5
VOP	00h	0Bh	Reserved	Reserved	Reserved	0	1	0	1	1	5.1
VOP	00h	0Ch	Reserved	Reserved	Reserved	0	1	1	0	0	5.2
VOP	00h	0Dh	Reserved	Reserved	Reserved	0	1	1	0	1	5.3
VOP	00h	0Eh	Reserved	Reserved	Reserved	0	1	1	1	0	5.4
VOP	00h	0Fh	Reserved	Reserved	Reserved	0	1	1	1	1	5.5
VOP	00h	10h	Reserved	Reserved	Reserved	1	0	0	0	0	5.6
VOP	00h	11h	Reserved	Reserved	Reserved	1	0	0	0	1	5.7
VOP	00h	12h	Reserved	Reserved	Reserved	1	0	0	1	0	5.8
VOP	00h	13h	Reserved	Reserved	Reserved	1	0	0	1	1	5.9
VOP	00h	14h	Reserved	Reserved	Reserved	1	0	1	0	0	6

#### **Table 3. VON Voltage Selection**

Name	Register Address	DATA	Bit7	Bit6	Bit5	Bit4	Bit3	Bit2	Bit1	Bit0	VON(V)
VON	01h	00h	Reserved	Reserved	Reserved	0	0	0	0	0	-4
VON	01h	01h	Reserved	Reserved	Reserved	0	0	0	0	1	-4.1
VON	01h	02h	Reserved	Reserved	Reserved	0	0	0	1	0	-4.2
VON	01h	03h	Reserved	Reserved	Reserved	0	0	0	1	1	-4.3
VON	01h	04h	Reserved	Reserved	Reserved	0	0	1	0	0	-4.4
VON	01h	05h	Reserved	Reserved	Reserved	0	0	1	0	1	-4.5
VON	01h	06h	Reserved	Reserved	Reserved	0	0	1	1	0	-4.6
VON	01h	07h	Reserved	Reserved	Reserved	0	0	1	1	1	-4.7
VON	01h	08h	Reserved	Reserved	Reserved	0	1	0	0	0	-4.8
VON	01h	09h	Reserved	Reserved	Reserved	0	1	0	0	1	-4.9
VON	01h	0Ah	Reserved	Reserved	Reserved	0	1	0	1	0	-5
VON	01h	0Bh	Reserved	Reserved	Reserved	0	1	0	1	1	-5.1
VON	01h	0Ch	Reserved	Reserved	Reserved	0	1	1	0	0	-5.2

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## **RT4801T**

Name	Register Address	DATA	Bit7	Bit6	Bit5	Bit4	Bit3	Bit2	Bit1	Bit0	VON(V)
VON	01h	0Dh	Reserved	Reserved	Reserved	0	1	1	0	1	-5.3
VON	01h	0Eh	Reserved	Reserved	Reserved	0	1	1	1	0	-5.4
VON	01h	0Fh	Reserved	Reserved	Reserved	0	1	1	1	1	-5.5
VON	01h	10h	Reserved	Reserved	Reserved	1	0	0	0	0	-5.6
VON	01h	11h	Reserved	Reserved	Reserved	1	0	0	0	1	-5.7
VON	01h	12h	Reserved	Reserved	Reserved	1	0	0	1	0	-5.8
VON	01h	13h	Reserved	Reserved	Reserved	1	0	0	1	1	-5.9
VON	01h	14h	Reserved	Reserved	Reserved	1	0	1	0	0	-6

#### Table 4. VOP Active Discharge

Name	Register Address	DATA	Bit7	Bit6	Bit5	Bit4	Bit3	Bit2	Bit1	Bit0	VOP Discharge
DISP	03h	00h	Reserved	APPS	Reserved	Reserved	Reserved	Reserved	0	DISN	W/O
DISP	03h	02h	Reserved	APPS	Reserved	Reserved	Reserved	Reserved	1	DISN	W

#### Table 5. VON Active Discharge

Name	Register Address	DATA	Bit7	Bit6	Bit5	Bit4	Bit3	Bit2	Bit1	Bit0	VON Discharge
DISN	03h	00h	Reserved	APPS	Reserved	Reserved	Reserved	Reserved	DISP	0	W/O
DISN	03h	01h	Reserved	APPS	Reserved	Reserved	Reserved	Reserved	DISP	1	W

#### **Table 6. Application**

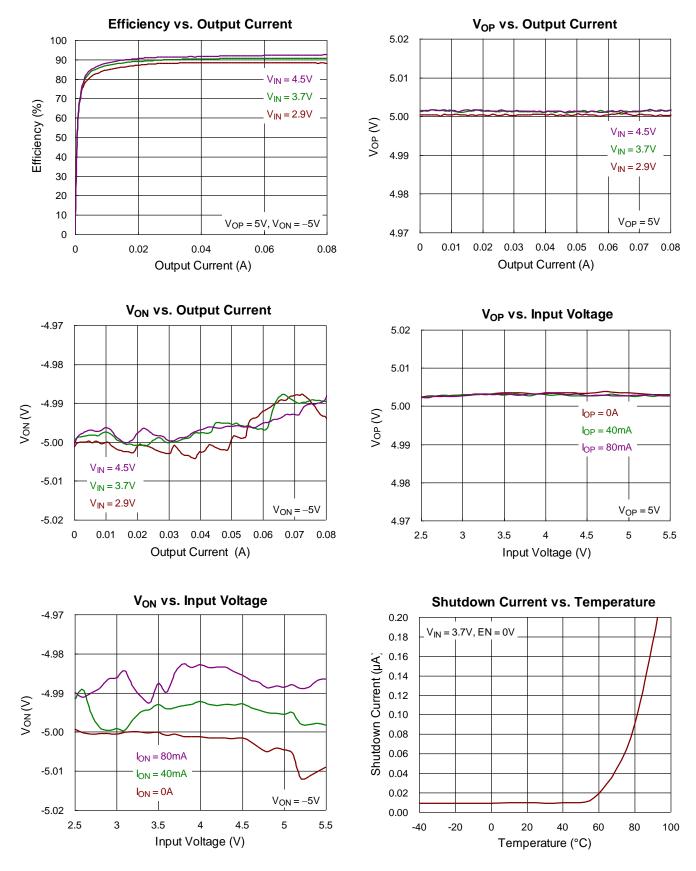
Name	Register Address	DATA	Bit7	Bit6	Bit5	Bit4	Bit3	Bit2	Bit1	Bit0	Application
APPS	03h	00h	Reserved	0	Reserved	Reserved	Reserved	Reserved	DISP	DISN	Tablet
APPS	03h	40h	Reserved	1	Reserved	Reserved	Reserved	Reserved	DISP	DISN	Smartphone

The Reserved bits are ignored when written and return either 0 or 1 when read.

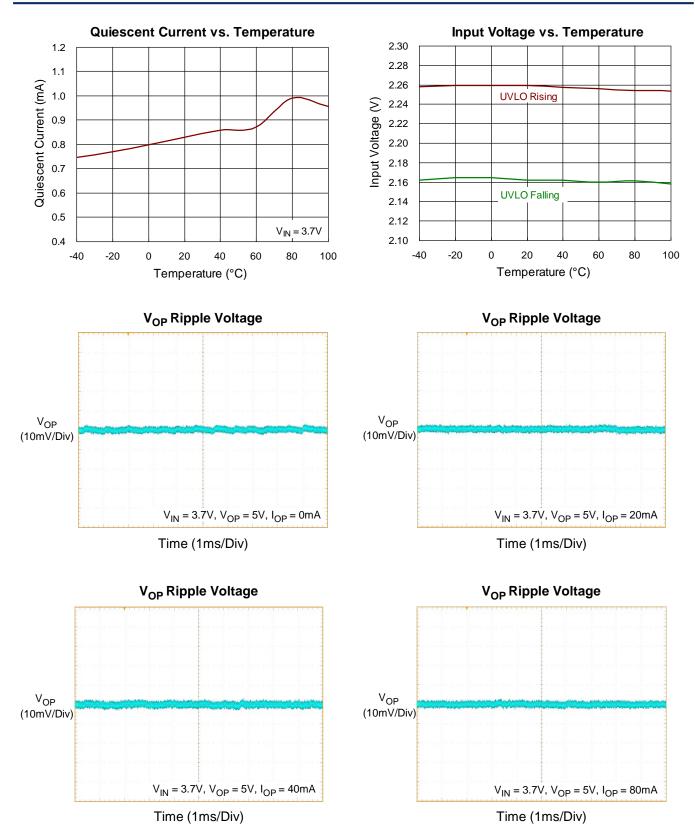
#### Factory Default Register Value

Name	Register Address	DATA
VOP	00h	0Ah
VON	01h	0Ah
DISP	03h	43h
DISN	03h	43h
APPS	03h	43h

### **Typical Operating Characteristics**



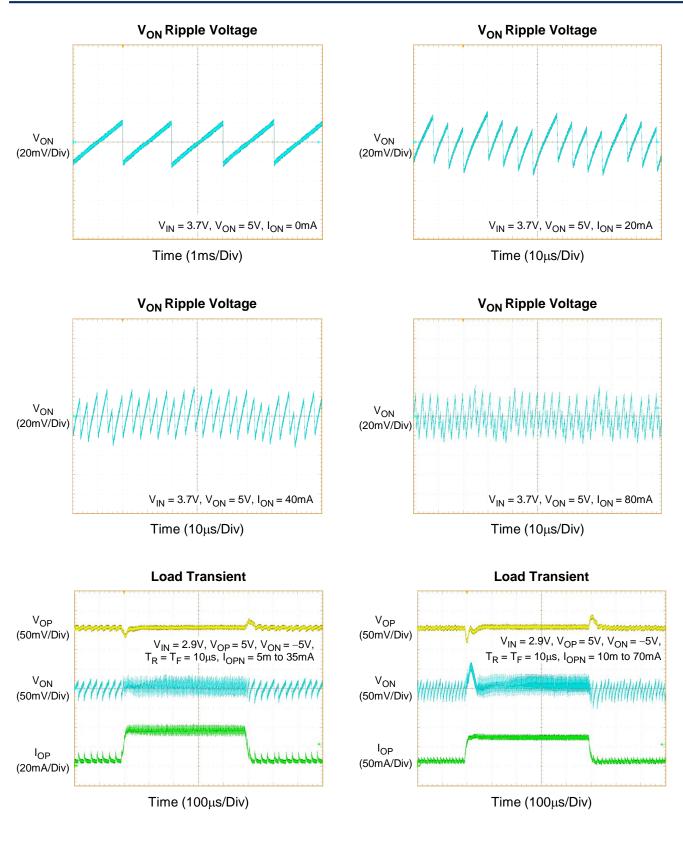
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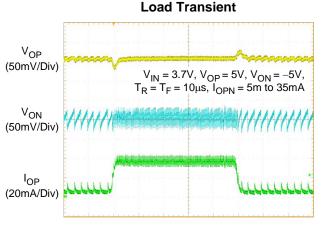
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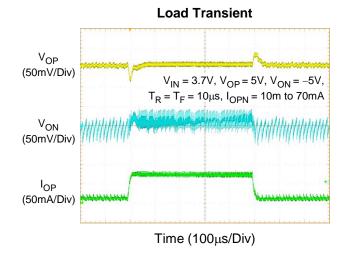
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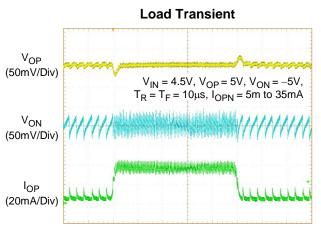
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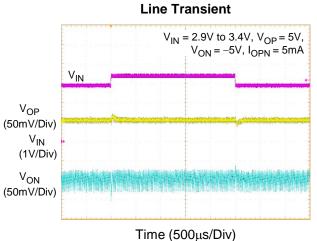


Time (100µs/Div)

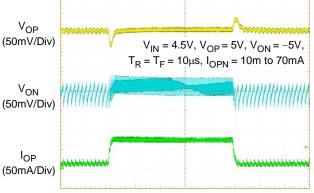




Time (100µs/Div)

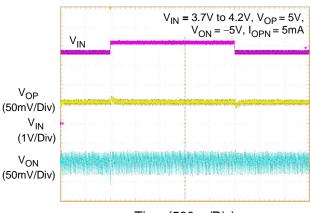


Load Transient



Time (100µs/Div)

Line Transient

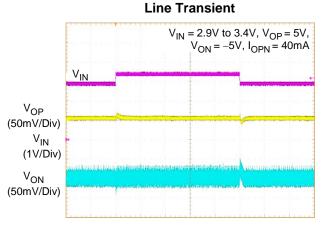


Time (500µs/Div)

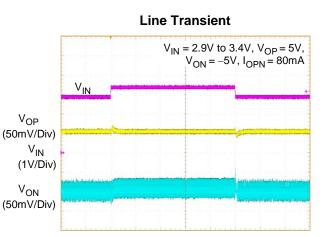
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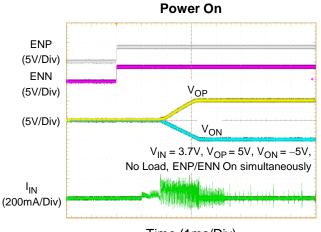




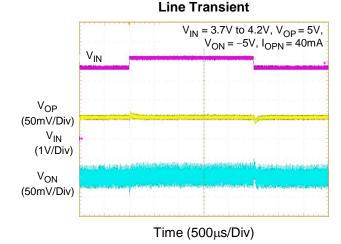
Time (500µs/Div)

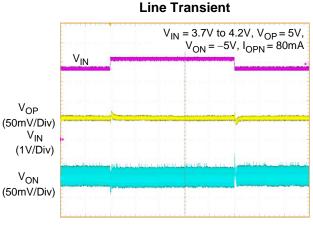


Time (500µs/Div)

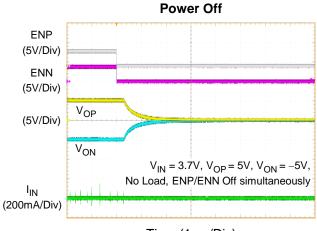


Time (1ms/Div)





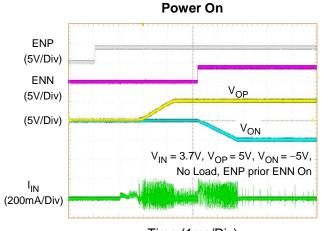
Time (500µs/Div)



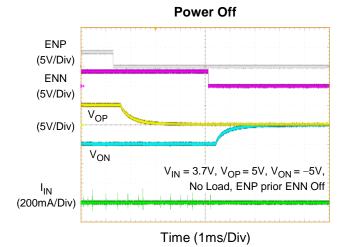
Time (1ms/Div)

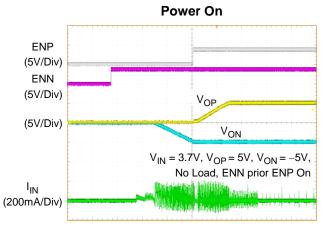
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## **RT4801T**



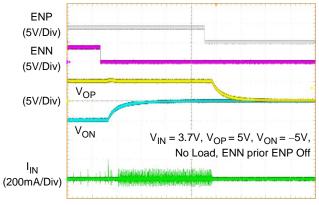
Time (1ms/Div)





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### Application Information

The RT4801T is a highly integrated Boost, LDO and inverting charge pump to generate positive and negative output voltages for LCD panel bias or consumer products. It can support input voltage range from 2.5V to 5.5V and the output current up to 150mA. The VOP positive output voltage is generated from the LDO supplied from a synchronous Boost converter, and VOP is set at a typical value of 5V. The Boost converter output also drives an inverting charge pump controller to generate V<sub>ON</sub> negative output voltage which is set at a typical value of -5V. Both positive and negative voltages can be programmed by a MCU through the dedicated I<sup>2</sup>C interface and the available voltage range is from  $\pm 4V$  to  $\pm 6V$  with 100mV per step.

#### **Input Capacitor Selection**

Input ceramic capacitor with 4.7µF capacitance is suggested for applications. For better voltage filtering, select ceramic capacitors with low ESR, X5R and X7R types are suitable because of their wider voltage and temperature ranges.

#### **Boost Inductor Selection**

The inductance depends on the maximum input current. As a general rule, the inductor ripple current range is 20% to 40% of the maximum input current. If 40% is selected as an example, the inductor ripple current can be calculated according to the following equations :

$$I_{IN(MAX)} = \frac{V_{OUT} \times I_{OUT(MAX)}}{\eta \times V_{IN}}$$
  
IRIPPLE = 0.4×I\_{IN(MAX)}

where  $\eta$  is the efficiency of the VOP Boost converter, IIN(MAX) is the maximum input current, and  $\Delta IL$  is the inductor ripple current. The input peak current can then be obtained by adding the maximum input current with half of the inductor ripple current as shown in the following equation :

 $IPEAK = 1.2 \times IIN(MAX)$ 

Note that the saturated current of the inductor must be greater than IPEAK.

The inductance can eventually be determined according to the following equation :

$$L = \frac{\eta \times (V_{IN})^2 \times (V_{OUT} - V_{IN})}{0.4 \times (V_{OUT})^2 \times I_{OUT(MAX)} \times f_{OSC}}$$

where fosc is the switching frequency. For better system performance, a shielded inductor is preferred to avoid EMI problems.

#### **Boost Output Capacitor Selection**

The output ripple voltage is an important index for estimating IC performance. This portion consists of two parts. One is the product of ripple current with the ESR of the output capacitor, while the other part is formed by the charging and discharging process of the output capacitor. As shown in Figure 1,  $\Delta VOUT1$  can be evaluated based on the ideal energy equalization. According to the definition of Q, the  $\Delta VOUT1$  value can be calculated as the following equation :

$$Q = I_{OUT} \times D \times \frac{1}{f_{SOC}} = C_{OUT} \times \Delta V_{OUT1}$$
$$\Delta V_{OUT1} = \frac{I_{OUT} \times D}{f_{SOC} \times C_{OUT}}$$

where fosc is the switching frequency and D is the duty cycle.

Finally, taking ESR into consideration, the overall output ripple voltage can be determined by the following equation :

$$\Delta V_{OUT} = \Delta V_{ESR} + \Delta V_{OUT1} = \Delta V_{SER} + \frac{I_{OUT} \times D}{f_{OSC} \times C_{OUT}}$$

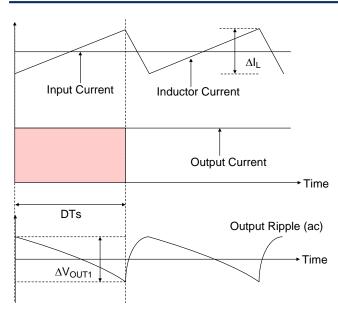
where  $\Delta VESR = ICrms x RCESR$ 

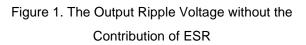
The output capacitor, COUT, should be selected accordingly.

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#### **Under Voltage Lockout**

To prevent abnormal operation of the IC in low voltage condition, an under voltage lockout is included which shuts down IC operation when input voltage is lower than the specified threshold voltage.

#### Soft-Start

The RT4801T employs an internal soft-start feature to avoid high inrush current during start-up. The soft-start function is achieved by clamping the output voltage of the internal error amplifier with another voltage source that is increased slowly from zero to near VIN during the soft-start period.

#### **Output Voltage Setting**

The output voltage of WL-CSP package can be programmed by a MCU through the dedicated  $I^2C$  interface according to the Vop/Von Voltage Selection Table.

#### Shut Down Delay and Discharge

When the EN signal is logic low for more than  $375\mu$ s, the output will be powered off. When the output discharge function is selected, the RT4801T starts to discharge the output voltage to ground with 20ms duration and then the output goes back to floating state. If the output continuous discharge function is required for application, the external resistor is recommended to

be paralleled with the output. In shut down mode, the input supply current for the IC is less than  $1\mu$ A.

#### **Over-Current Protection**

The RT4801T includes a cycle-by-cycle current limit function which monitors the inductor current during each ON period. The power switch will be forced off to avoid large current damage once the current is over the limit level.

#### **Output Short Circuit Protection**

The RT4801T has an advanced output short-circuit protection mechanism which prevents the IC from damage by unexpected applications.

#### VOP short to ground

When the output current is higher than the current limit level 250mA (typ.) for 1ms (typ.), both VPOS and VON outputs shut down and only can re-start to normal operation after re-toggling the ENP/ENN pin.

#### VON short to ground

The RT4801T activates short-circuit protection once the VON voltage drops below 75% (typ.) of target voltage due to excessive loading. The protection stops after the VON voltage backs to higher than the protection level for 1ms (typ.). There is not any influence on VOP.

#### **Over-Temperature Protection**

The RT4801T equips an over-temperature protection circuitry to prevent overheating due to excessive power dissipation. The OTP will shut down LCD bias operation when ambient temperature exceeds 140°C. Once the ambient temperature cools down by approximately 15°C, IC will automatically resume normal operation. To maintain continuous operation, the maximum junction temperature should be prevented from rising above 125°C.

#### Thermal Considerations

The junction temperature should never exceed the absolute maximum junction temperature  $T_{J(MAX)}$ , listed under Absolute Maximum Ratings, to avoid permanent damage to the device. The maximum allowable power dissipation depends on the thermal resistance of the IC package, the PCB layout, the rate of surrounding airflow, and the difference between the junction and ambient

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temperatures. The maximum power dissipation can be calculated using the following formula :

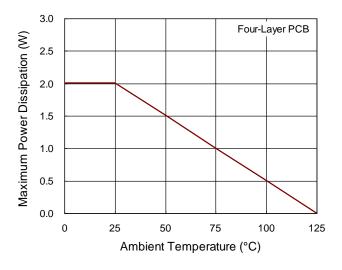
 $\mathsf{PD}(\mathsf{MAX}) = (\mathsf{TJ}(\mathsf{MAX}) - \mathsf{TA}) / \theta \mathsf{JA}$ 

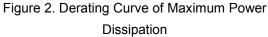
where  $T_{J(MAX)}$  is the maximum junction temperature,  $T_A$  is the ambient temperature, and  $\theta_{JA}$  is the junction-to-ambient thermal resistance.

For continuous operation, the maximum operating junction temperature indicated under Recommended Operating Conditions is 125°C. The junction-to-ambient thermal resistance,  $\theta_{JA}$ , is highly package dependent. For a WL-CSP-15B 1.31x2.07 (BSC) package, the thermal resistance,  $\theta_{JA}$ , is 49.8°C/W on a standard JEDEC 51-7 high effective-thermal-conductivity four-layer test board. The maximum power dissipation at TA = 25°C can be calculated as below :

 $P_{D(MAX)} = (125^{\circ}C - 25^{\circ}C) / (49.8^{\circ}C/W) = 2W$  for a WL-CSP-15B 1.31x2.07 (BSC) package.

The maximum power dissipation depends on the operating ambient temperature for the fixed  $T_{J(MAX)}$  and the thermal resistance,  $\theta_{JA}$ . The derating curves in Figure 2 allows the designer to see the effect of rising ambient temperature on the maximum power dissipation.





#### Layout Considerations

For the best performance of the RT4801T, the following PCB layout guidelines should be strictly followed.

- For good regulation, place the power components as close to the IC as possible. The traces should be wide and short especially for the high current output loop.
- The input and output bypass capacitor should be placed as close to the IC as possible and connected to the ground plane of the PCB.
- The flying capacitor should be placed as close to the CF1/CF2 pin as possible to avoid noise injection.
- Minimize the size of the LXP node and keep the traces wide and short. Care should be taken to avoid running traces that carry any noise-sensitive signals near LXP or high-current traces.
- Separate power ground (PGND) and analog ground (GND). Connect the GND and the PGND islands at a single end. Make sure that there are no other connections between these separate ground planes.



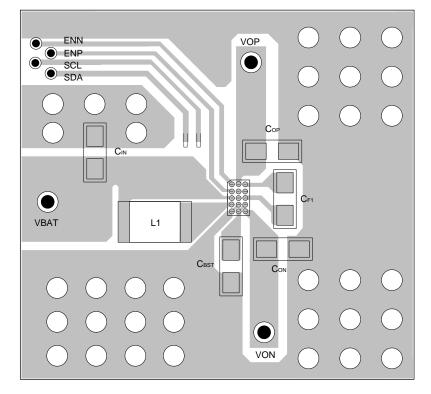
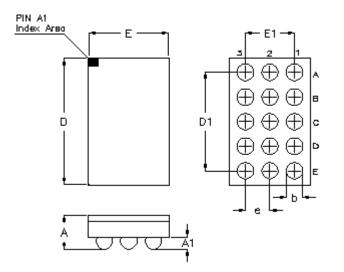


Figure 3. PCB Layout Guide







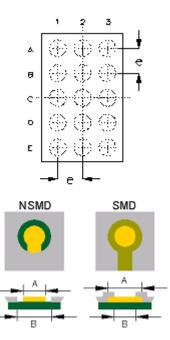
Symbol	Dimensions I	n Millimeters	<b>Dimensions In Inches</b>			
Symbol	Min	Max	Min	Мах		
А	0.500 0.600		0.020	0.024		
A1	0.170	0.230	0.007	0.009		
b	0.240	0.300	0.009	0.012		
D	2.020	2.120	0.080	0.083		
D1	1.6	600	0.063			
E	1.260	1.360	0.050	0.054		
E1	0.8	300	0.031			
е	0.4	100	0.016			

WL-CSP-15B 1.31x2.07 (BSC)

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### **Footprint Information**



Deekogo	Number of		Footpri	Tolerance			
Package	Pin	Туре	е	А	В	TOIETATICE	
	15	NSMD	0.400	0.240	0.340	.0.005	
WL-CSP1.31x2.07-15(BSC)	15	SMD		0.270	0.240	±0.025	

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